■ SPECIFICATION

Item		High sensitive type	500 mW type	High dielectric strength	2 A type	Continous (MBB)type
		RY-()W-K	RY-()WZ-K	RY-()WF-K	RY-()WFZ-K	RY-()D-K
Contact	Configuration	2 form C (DPDT)			2 form D (2 MBB)	
Data	Construction	Bifurcated (cross	Single			
	Material	Gold overlay silve	er-palladium	Gold overlay silver-nickel	Gold overlay silver- palladium	
	Resistance (initial)	Max. 100 mΩ at	6 VDC, 1A			
	Contact rating	1A, 24VDC 0.5A, 120VAC		1A, 24VDC 0.25A,120VAC	2A, 30VDC 0.5A,125VAC	0.15A, 48VDC 0.3A, 120VAC
	Max. carrying current	1.25A			2A	0.6A
	Max. switching voltage	120VAC, 60VDC	AC, 60VDC 125VAC, 150VDC			120VAC, 60VDC
	Max. switching power	60VA / 24W 30VA / 24W			62.5VA /60W	36VA / 7.2W
	Max. switching current					
	Min. switching load *	0.01 mA, 10 mV[OC .		0.1 mA, 10 mVDC	
	Capacitance (at 10MHz)	Approximately 0. Approximately 1.				
Life	Mechanical	Min. 20 x 10 ⁶ operations	Min. 10 x 10 ⁶ o	perations		Min. 1 x 10 ⁶ operations
	Electrical (at contact rating)	Min. 200 x 10 ³ operations (0.5A, 120VAC) Min. 500 x 10 ³ operations (1A, 24VDC)		Min. 500x10 ³ operations (0.25A, 120VAC) (1A, 4VDC)	Min. 100x10 ³ operations (2A, 30VDC)	Min.200x10 ³ ops. (0.3A, 120VAC) Min.500x10 ³ ops. (0.15A, 48VDC)
Coil Data	Rated power	150 - 300mW	500 - 580mW	450 - 460mW	500 - 580mW	450 - 480mW
	Operate power	75 -140mW	125 - 145mW	200 - 210mW	200 - 324mW	200 - 210mW
	Operating temperature range (no frost)	-30 °C to +90 °C (+80 °C for 48VDC type)	-30 °C to +60 °C		1	-30 °C to +70 °C (+65 °C for 48VDC type)

^{*} Minimum switching loads mentioned above are reference values. Please perform the confirmation test with actual load before production since reference values may vary according to switching frequencies, environmental conditions and expected reliability levels.

SPECIFICATION (CONTINUED)

Item			High sen- sitive type	500 mW type	High dielectric strength	2 A type	Continous (MBB) type
			RY-()W-K	RY-()WZ-K	RY-()WF-K	RY-()WFZ-K	RY-()D-K
Timing Data	Operate (at nominal vo	oltage)	Max. 6 ms				
	Release (at nominal vo	oltage)	Max. 3 ms				
Insulation	Resistance (initial)		Min. 1,000/	MΩ at 500VDC			
	Dielectric strength	Open contacts	500VAC, 1min		1,000VAC, 1min.	500VAC, 1min	
		Contacts to coil/ adjacent contacts	1,000VAC 1min				
	Surge strength	Coil to contacts	1,500V / 10 x 160µs standard wave				
Other	Misoperation		10 to 55Hz double amplitude 1.5 mm				
	Vibration resistance	Endurance	10 to 55Hz double amplitude 4.5 mm				
	Misoperation		Min. 100m/s ² (11 ± 1ms)				
	Shock resistance	Endurance	Min. 1,000m/s² (6 ± 1ms)				
	Weight		Approximately 5 g				
	Sealing		Sealed cat. RTIII				

COIL RATING

High sensitive type (RY-xxW-K)

Coil Code	Rated Coil Voltage (VDC)	Coil Resistance +/- 10% (Ohm)	Must Operate Voltage (VDC) *	Must Release Voltage (VDC) *	Rated Power (mW)
3	3	60	2.1	0.15	
4.5	4.5	135	3.2	0.23	
5	5	165	3.6	0.25	150
6	6	240	4.3	0.3	
9	9	540	6.4	0.45	
12	12	960	8.5	0.6	
18	18	1,620	12.6	0.9	200
24	24	2,880	16.8	1.2	200
48	48	7,680	32.6	2.4	300

Note: All values in the table are valid for 20°C and zero contact current. * Specified operate values are valid for pulse wave voltage.

3

500 mW type (RY-xxWZ-K)

Coil Code	Rated Coil Voltage (VDC)	Coil Resistance +/- 10% (Ohm)	Must Operate Voltage (VDC) *	Must Release Voltage (VDC) *	Rated Power (mW)
3	3	18	1.5	0.15	500
4.5	4.5	36	2.25	0.23	560
5	5	45	2.5	0.25	300
6	6	66	3	0.3	550
9	9	140	4.5	0.45	580
12	12	280	6	0.6	510
18	18	560	9	0.9	580
24	24	1,070	12	1.2	540
48	48	4,000	24	2.4	580

High dielectric type (RY-xxWF-K)

Coil Code	Rated Coil Voltage (VDC)	Coil Resistance +/- 10% (Ohm)	Must Operate Voltage (VDC) *	Must Release Voltage (VDC) *	Rated Power (mW)
5	5	56	3.3	0.25	
6	6	80	4	0.3	
9	9	180	6	0.45	450
12	12	320	8	0.6	
18	18	720	12	0.9	
24	24	1,260	15.9	1.2	
48	48	5,000	33	2.4	460

2A type (RY-xxWFZ-K)

Coil Code	Rated Coil Voltage (VDC)	Coil Resistance +/- 10% (Ohm)	Must Operate Voltage (VDC) *	Must Release Voltage (VDC) *	Rated Power (mW)
3	3	18	1.9	0.15	500
4.5	4.5	36	2.9	0.23	
5	5	45	3.2	0.25	560
6	6	66	3.8	0.3	550
9	9	140	5.7	0.45	580
12	12	280	7.6	0.6	510
18	18	560	11.4	0.9	580
24	24	1,070	15.2	1.2	540
48	48	4,000	36	2.4	580

Note: All values in the tables are measured at 20°C and zero contact current. * Specified values are measured with pulse wave voltage

MBB type (RY-xxD-K)

Coil Code	Rated Coil Voltage (VDC)	Coil Resistance +/- 10% (Ohm)	Must Operate Voltage (VDC) *	Must Release Voltage (VDC) *	Rated Power (mW)
4.5	4.5	45	3	0.23	
5	5	55	3.3	0.25	
6	6	80	3.95	0.3	450
9	9	180	5.9	0.45	
12	12	320	7.9	0.6	
18	18	720	11.8	0.9	
24	24	1,280	15.8	1.2	
48	48	4,800	31.8	2.4	480

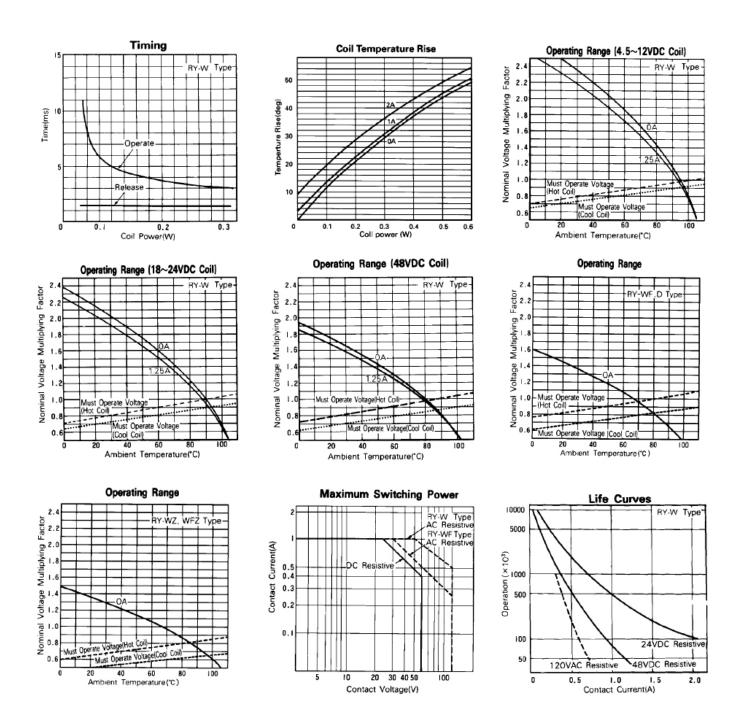
Note: All values in the table are measured at 20°C and zero contact current. ${\bf *}$ Specified values are measured with pulse wave voltage

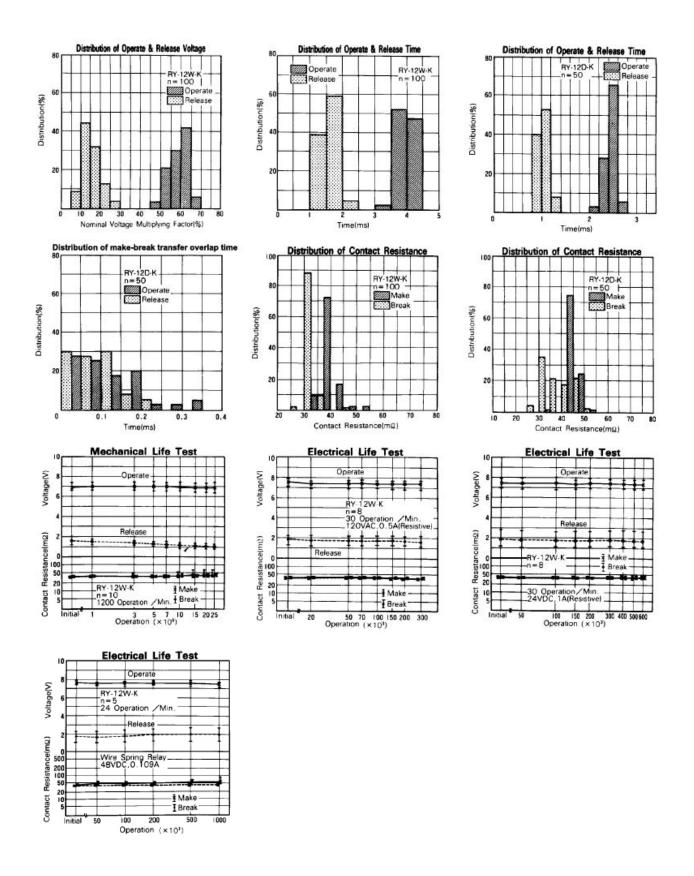
SAFETY STANDARDS *

Туре	Compliance	Contact rating
UL	UL 478, UL 508	Flammability: UL 94-V0 (plastics)
	E 45026	[RY-W, RY-WZ] 0.5A, 120VAC (resistive)
CSA	C22.2 No. 14 LR 35579	1A, 24VDC (resistive) 0.3A, 60VDC (resistive) 2A, 30VDC, (resistive) [RY-WF] 0,5A,120VAC (resistive) (UL) 0.25A, 120VAC (resistive) (CSA) 1A, 24VDC (resistive) 0.3A, 60VDC (resistive) 2A, 30VDC (resistive) [RY-D] 0.3A, 120VAC (resistive) 0.2A, 60VDC (resistive) [RY-WFZ] 0.5A, 125VAC (resistive) 2A, 30VDC (resistive) 0.6A, 110VDC (resistive)

^{*} Note: for UL/CSA certified relays; UL/CSA marking, add -UL to the ordering partnumber

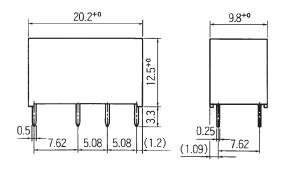
■ CHARACTERISTIC DATA



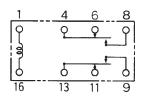


■ DIMENSIONS

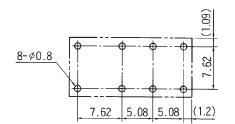
Dimensions



Schematics (BOTTOM VIEW)



 PC board mounting hole layout (BOTTOM VIEW)



Unit: mm

RoHS Compliance and Lead Free Information

1. General Information

- All relays produced by Fujitsu Components are compliant with RoHS directive 2011/65/EU including amendments.
- Cadmium as used in electrical contacts is exempted from the RoHS directives.
 As per Annex III of directive 2011/65/EU.
- All relays are lead-free. Please refer to Lead-Free Status Info for older date codes at: http://www.fujitsu.com/downloads/MICRO/fcai/relays/lead-free-letter.pdf
- Lead free solder plating on relay terminals is Sn-3.0Ag-0.5Cu, unless otherwise specified. This material has been verified to be compatible with PbSn assembly process.

2. Recommended Lead Free Solder Condition

• Recommended solder Sn-3.0Ag-0.5Cu.

Flow Solder Condition:

Pre-heating: maximum 120°C

within 90 sec.

Soldering: dip within 5 sec. at

255°C ± 5°C solder bath

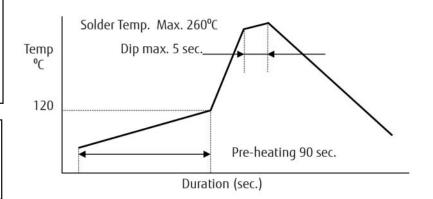
Relay must be cooled by air immediately

after soldering

Solder by Soldering Iron:

Soldering Iron 30-60W

Temperature: maximum 350-360°C Duration: maximum 3 sec.



We highly recommend that you confirm your actual solder conditions

3. Moisture Sensitivity

• Moisture Sensitivity Level standard is not applicable to electromechanical relays, unless otherwise indicated.

4. Tin Whiskers

• Dipped SnAgCu solder is known as presenting a low risk to tin whisker development. No considerable length whisker was found by our in house test.

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